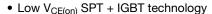


Molding Type Module IGBT, Chopper in 1 Package, 1200 V and 300 A

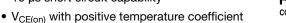


PRODUCT SUMMARY					
V_{CES}	1200 V				
I _C at T _C = 80 °C	300 A				
V _{CE(on)} (typical) at I _C = 300 A, 25 °C	2.0 V				
Speed	8 kHz to 30 kHz				
Package	Double INT-A-PAK				
Circuit	Chopper high side switch				

FEATURES







- Low inductance case
- · Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- · Inverter for motor drive
- · AC and DC servo drive amplifier
- Uninterruptible power supply (UPS)

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		1200	V	
Gate to emitter voltage	V _{GES}		± 20	V	
O-Hantau august		T _C = 25 °C	500		
Collector current	I _C	T _C = 80 °C	300		
Pulsed collector current	I _{CM} ⁽¹⁾	t _p = 1 ms	600	А	
Diode continuous forward current	I _F	T _C = 80 °C	300		
Diode maximum forward current	I _{FM}	t _p = 1 ms	600		
Maximum power dissipation	P _D	T _J = 150 °C	1645	W	
Short circuit withstand time	t _{SC}	T _J = 125 °C	10	μs	
RMS isolation voltage	V _{ISOL}	f = 50 Hz, t = 1 min	2500	V	

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature.



IGBT ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN.		TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	T _J = 25 °C	1200	-	-	
Collector to emitter voltage	V _{CE(on)}	$V_{GE} = 15 \text{ V}, I_{C} = 300 \text{ A}, T_{J} = 25 \text{ °C}$	-	2.0	2.45	V
		$V_{GE} = 15 \text{ V}, I_{C} = 300 \text{ A}, T_{J} = 125 ^{\circ}\text{C}$	-	2.2	-	
Gate to emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$, $I_C = 12$ mA, $T_J = 25$ °C	5.0	6.2	7.0	
Collector cut-off current	I _{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0$ V, $T_{J} = 25$ °C	-	-	5.0	mA
Gate to emitter leakage current	I _{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0$ V, $T_J = 25$ °C	-	-	400	nA

SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t _{d(on)}		-	574	-	ns mJ
Rise time	t _r		-	133	-	
Turn-off delay time	t _{d(off)}	$V_{CC} = 600 \text{ V}, I_{C} = 300 \text{ A}, R_{g} = 4.7 \Omega,$	-	563	-	
Fall time	t _f	V _{GE} = ± 15 V, T _J = 25 °C	-	120	-	
Turn-on switching loss	E _{on}		-	23.9	-	
Turn-off switching loss	E _{off}		-	25.3	-	
Turn-on delay time	t _{d(on)}		-	604	-	ns ns
Rise time	t _r		-	137	-	
Turn-off delay time	t _{d(off)}	$V_{CC} = 600 \text{ V}, I_{C} = 300 \text{ A}, R_{g} = 4.7 \Omega,$	-	629	-	
Fall time	t _f	V _{GE} = ± 15 V, T _J = 125 °C	-	167	-	
Turn-on switching loss	E _{on}		-	31.5	-	m l
Turn-off switching loss	E _{off}		-	35.9	-	- mJ
Input capacitance	C _{ies}		-	21.2	-	
Output capacitance	C _{oes}	V _{GE} = 0 V, V _{CE} = 25 V, f = 1.0 MHz	-	1.42	-	nF
Reverse transfer capacitance	C _{res}		-	0.94	-	
SC data	I _{SC}	$t_{sc} \le 10 \ \mu s, \ V_{GE} = 15 \ V, \ T_J = 125 \ ^{\circ}C, \ V_{CC} = 900 \ V, \ V_{CEM} \le 1200 \ V$	-	1800	-	Α
Internal gate resistance	R_g		-	1.0	-	Ω
Stray inductance	L _{CE}		-	-	20	nΗ
Module lead resistance, terminal to chip	R _{CC'+EE'}	T _C = 25 °C	=	0.35	-	mΩ

DIODE ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Diode forward voltage	\/_	/ _E	$T_J = 25 ^{\circ}C$	-	1.82	2.25	V	
blode lorward voltage	V_F $I_F = 30$	IF = 300 A	T _J = 125 °C	-	1.95	-		
Die de verreure verene elemen	Q _{rr}		T _J = 25 °C	-	20.2	-		
Diode reverse recovery charge			T _J = 125 °C	-	40.1	-	μC	
Diede peak reverse resource current			$I_F = 300 \text{ A}, V_R = 600 \text{ V},$ $dI_F/dt = -2360 \text{ A/}\mu\text{s},$	T _J = 25 °C	-	170	-	^
Diode peak reverse recovery current	I _{rr}	$V_{GF} = -15 \text{ V}$	T _J = 125 °C	-	250	-	Α	
Diada vayaya vaaayan anavay	E _{rec}	32	T _J = 25 °C	-	8.2	=	mJ	
Diode reverse recovery energy			T _J = 125 °C	-	21.7	-	1110	



THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature	TJ		-	-	150	°C
Storage temperature range	T _{STG}		-40	-	125	
Junction to case	Б		-	-	0.076	
Diode	R _{thJC}		-	-	0.100	K/W
Case to sink	R _{thCS}	Conductive grease applied	-	0.035	-	
Mounting torque		Power terminal screw: M6	2.5 to 5.0		Nm	
		Mounting screw: M6	3.0 to 5.0		INIII	
Weight				300		g

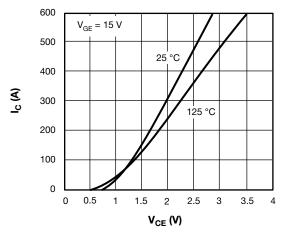


Fig. 1 - IGBT Typical Output Characteristics

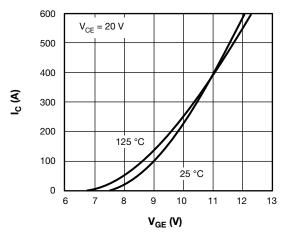


Fig. 2 - IGBT Typical Transfer Characteristics

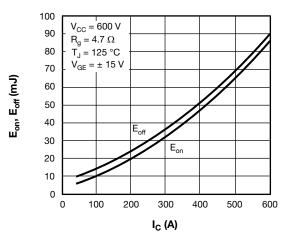


Fig. 3 - IGBT Switching Loss vs. $I_{\mathbb{C}}$

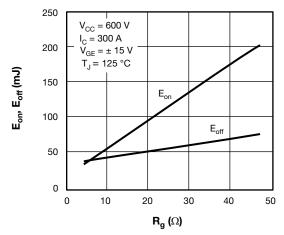


Fig. 4 - IGBT Switching Loss vs. Ra

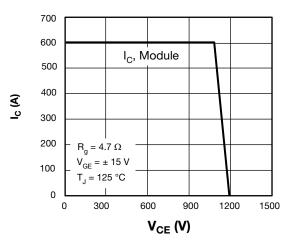


Fig. 5 - RBSOA

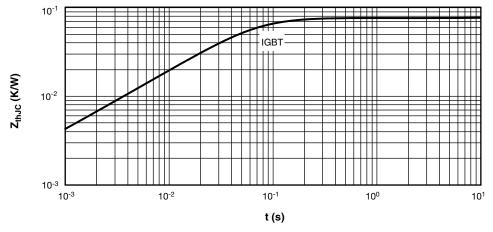


Fig. 6 - IGBT Transient Thermal Impedance

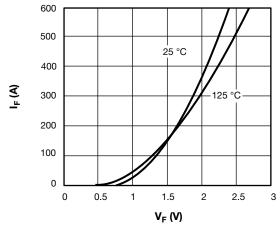


Fig. 7 - Diode Typical Forward Characteristics

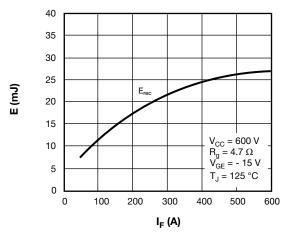


Fig. 8 - Diode Switching Loss vs. IF

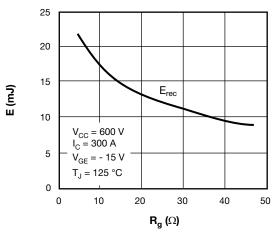


Fig. 9 - Diode Switching Loss vs. Rg

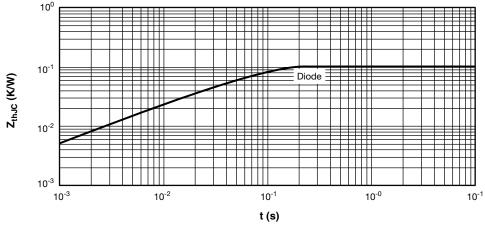
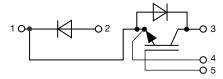


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION

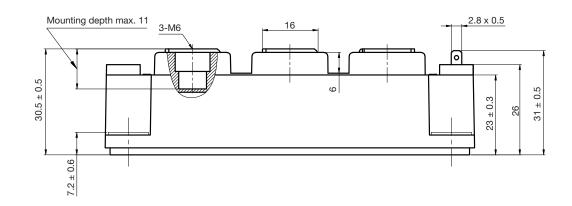


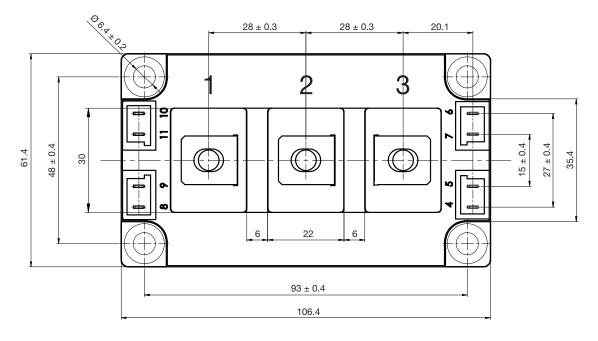
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95525			



Double INT-A-PAK

DIMENSIONS in millimeters (inches)







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